

## **SSC8K21GN3**

**P-Channel Enhancement Mode MOSFET with Schottky Diode**

➤ **Features**

**P-Channel**

VDS	VGS	RDS(on) Typ.	ID
-20V	$\pm 8V$	130m $\Omega$ @-4V5	-2A
		170m $\Omega$ @-2V5	
		230m $\Omega$ @-1V8	

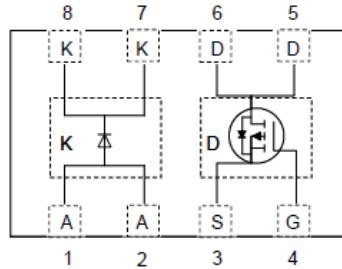
**Schottky**

VR	IR	VF Typ.	IO
20V	15uA	410mV @0.5A	1A

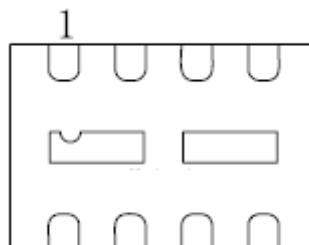
➤ **Description**

SSC8K21GN3 combines an P-Channel enhancement mode power MOSFET which is produced with high cell density and DMOS trench technology and a low forward voltage Schottky diode. The tiny and thin outline saves PCB consumption.

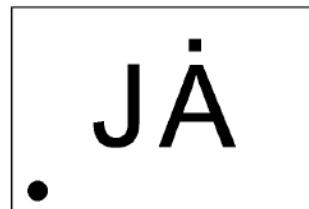
➤ **Pin configuration**



**Top View**



**Bottom View**



**Marking**

➤ **Applications**

- Li-Battery Charging
- High Side DC/DC Converter
- High Side Driver for Brushless DC motor
- Power Management in Portable, Battery Powered Devices

➤ **Ordering Information**

Device	Package	Shipping
SSC8K21GN3	DFN3X2	3000/Reel

**SSC8K21GN3**➤ **Absolute Maximum Ratings ( $T_A=25^\circ\text{C}$  unless otherwise noted)**

Symbol	Parameter	Ratings	Unit
P-MOS			
$V_{DSS}$	Drain-to-Source Voltage	-20	V
$V_{GSS}$	Gate-to-Source Voltage	$\pm 8$	V
$I_D$	Continuous Drain Current	-2	A
$I_{DM}$	Pulsed Drain Current	-8	A
Schottky Diode			
$V_R$	Schottky Reverse Voltage	20	V
$I_F$	Schottky Continuous Forward Current	1	A
Power Dissipation and Temperature			
$P_D$	Power Dissipation	2.2	W
$T_J$	Operation junction temperature	-55 to 150	$^\circ\text{C}$
$T_{STG}$	Storage temperature range	-55 to 150	$^\circ\text{C}$

➤ **Thermal Resistance Ratings ( $T_A=25^\circ\text{C}$  unless otherwise noted)**

Symbol	Parameter	Value	Unit
$R_{\theta JA}$	Junction-to-Ambient Thermal Resistance	59	$^\circ\text{C}/\text{W}$

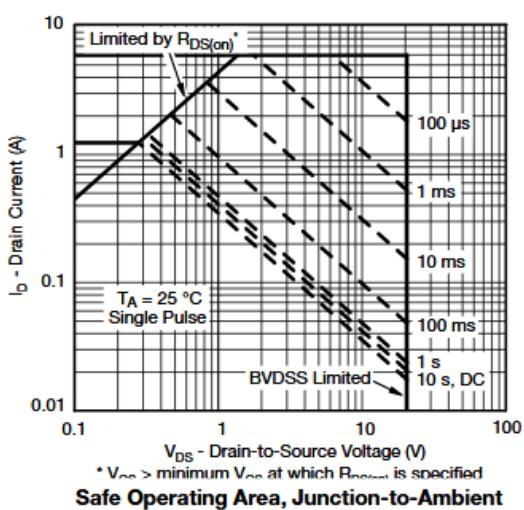
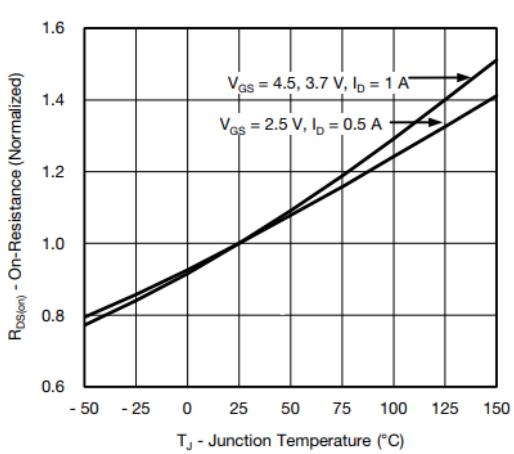
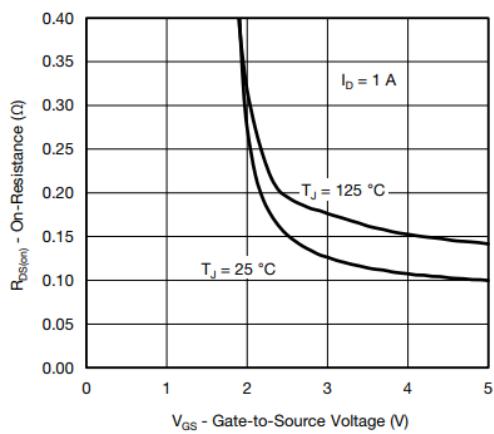
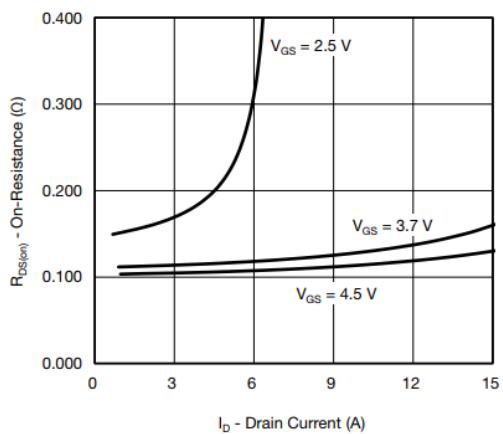
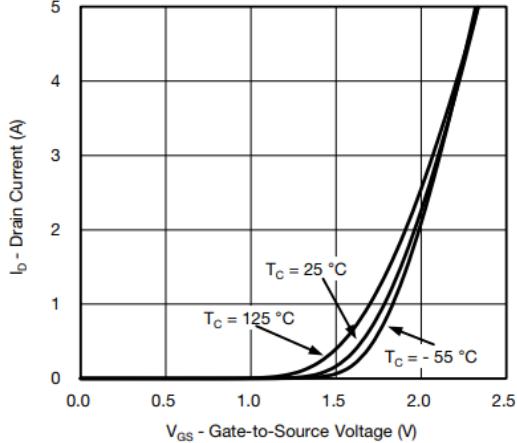
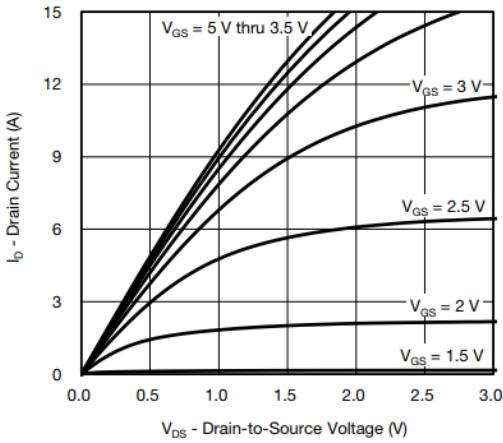
➤ **Electronics Characteristics ( $T_A=25^\circ\text{C}$  unless otherwise noted)**

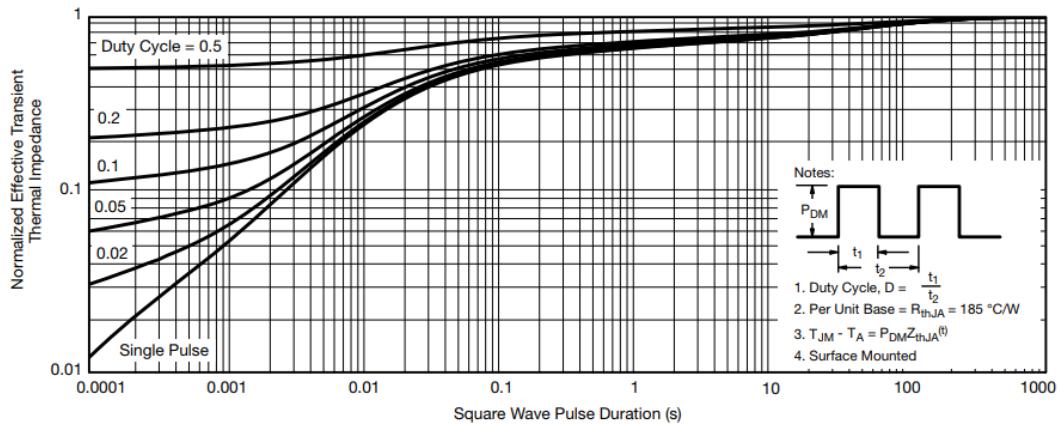
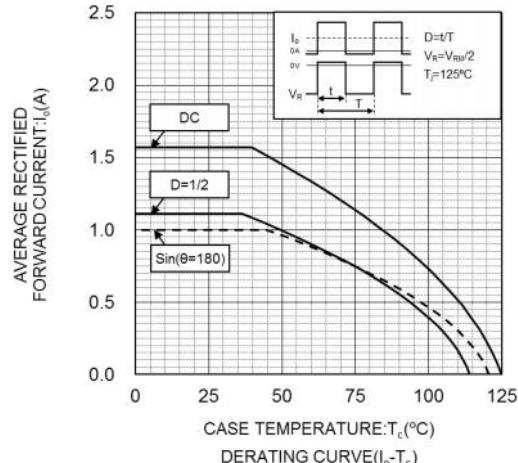
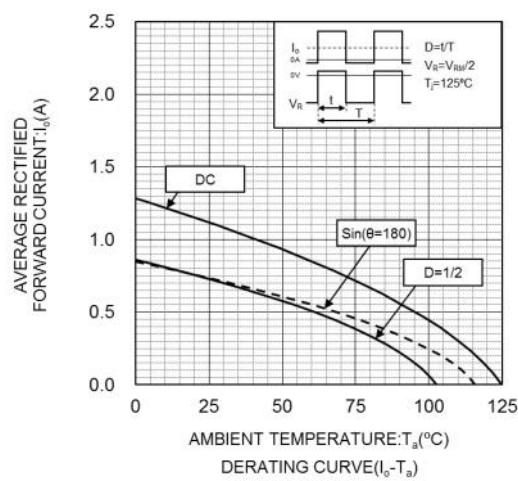
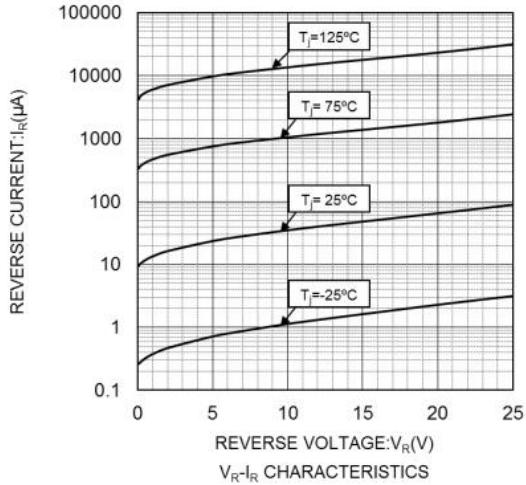
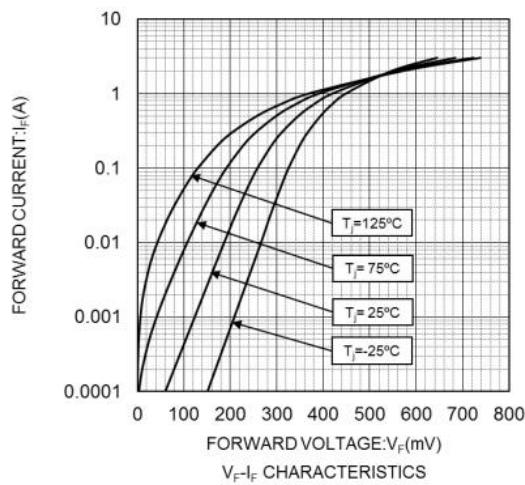
Symbol	Parameter	Test Conditions	Min	Typ.	Max	Unit
Schottky						
$B_V$	Reverse Breakdown Voltage	$IR=100\mu\text{A}$	20			V
$VF$	Forward Voltage Drop	$IF=0.5\text{A}$		0.41	0.49	V
$IR$	Maximum reverse leakage current	$VR=20\text{V}$		15	200	$\mu\text{A}$



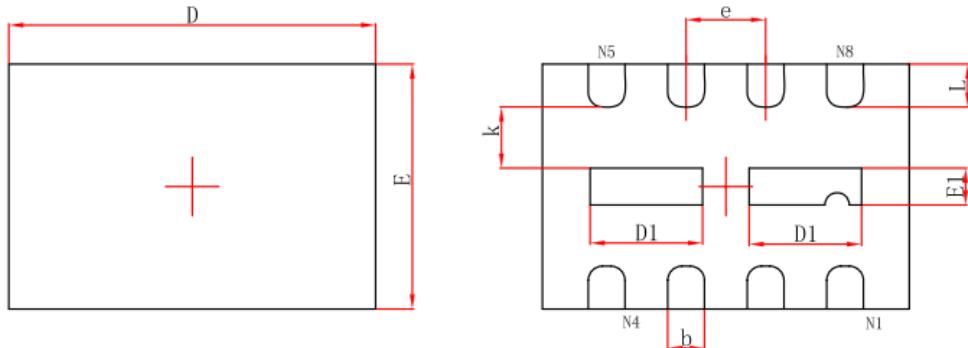
Symbol	Parameter	Test Conditions	Min	Typ.	Max	Unit
P-Channel Enhancement Mode MOSFET						
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V$ , $ID=-250\mu A$	-20			V
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS}=V_{GS}$ , $ID=-250\mu A$	-0.5	-0.6	-1.2	V
$R_{DS(on)}$	Drain-Source On-Resistance	$V_{GS}=-4.5V, ID=-0.5A$		130	190	$m\Omega$
		$V_{GS}=-2.5V, ID=-0.5A$		170	250	
		$V_{GS}=-1.8V, ID=-0.5A$		230	500	
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS}=-20V$ , $V_{GS}=0V$			-1	$\mu A$
$I_{GSS}$	Gate-Source leak current	$V_{GS}=\pm 8V$ , $V_{DS}=0V$			$\pm 100$	nA
$G_{FS}$	Transconductance	$V_{DS}=-10V$ , $ID=-1.7A$		7		S
$V_{SD}$	Forward Voltage	$V_{GS}=0V$ , $IS=-1A$			1.3	V
$C_{iss}$	Input Capacitance	$V_{DS}=-10V$ , $V_{GS}=0V$ , $f=1MHz$		476		$pF$
$C_{oss}$	Output Capacitance			187		
$C_{rss}$	Reverse Transfer Capacitance			78		
$T_{D(ON)}$	Turn-on delay time	$V_{DS}=-6V$ , $V_{GS}=-4.5V$ , $RL=6R$ , $RG=6R$ , $ID=-1A$		19		$ns$
$Tr$	Turn-on rise time			31		
$T_{D(OFF)}$	Turn-off delay time			168		
$Tf$	Turn-off fall time			102		

➤ **Typical Characteristics ( $T_A=25^\circ\text{C}$  unless otherwise noted)**



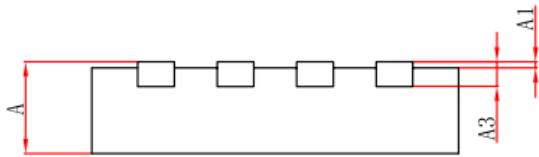

**Normalized Thermal Transient Impedance, Junction-to-Ambient**


## ➤ Package Information



**Top View**

**Bottom View**



**Side View**

**DFN3X2-8L**

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.700/0.800	0.800/0.900	0.028/0.031	0.031/0.035
A1	0.000	0.050	0.000	0.002
A3	0.153	0.253	0.006	0.010
D	2.9	3.1	0.114	0.122
E	1.9	2.1	0.075	0.083
D1	0.82	1.020	0.032	0.040
E1	0.200	0.400	0.008	0.016
k	0.300MIN.		0.010MIN.	
b	0.250	0.350	0.010	0.014
e	0.650TYP.		0.026TYP.	
L	0.250	0.350	0.010	0.014

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